

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Chan-hoon Park

Docket No.

SEC.689

Serial No.
09/484,051Filing Date
18 January 2000Examiner
C. AtkinsonGroup Art Unit
3743Invention: **WAFER HEATING APPARATUS HAVING FLUID HEAT TRANSFER MEDIUM AND METHOD OF HEATING A WAFER USING THE SAME**

MAR 14 2002

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	9 -	20 =	0	x \$18.00	\$0.00
INDEP. CLAIMS	3 -	3 =	0	x \$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

No additional fee is required for amendment.

Please charge Deposit Account No. in the amount of
A duplicate copy of this sheet is enclosed.

A check in the amount of to cover the filing fee is enclosed.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-0238
A duplicate copy of this sheet is enclosed.

Any additional filing fees required under 37 C.F.R. 1.16.

Any patent application processing fees under 37 CFR 1.17.



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I certify that this document and fee is being deposited on MAR 21 2002 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

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#13
SEC.689 KC
3-28-02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Chan-hoon PARK

Group Art Unit: 3743

Serial No.: 09/484,051

Examiner: C. Atkinson

Filed: January 18, 2000

For: WAFER HEATING APPARATUS HAVING FLUID HEAT TRANSFER MEDIUM
AND METHOD OF HEATING A WAFER USING THE SAME

SUPPLEMENTAL RESPONSE

Honorable Assistant Commission for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action mailed on 25 February 2002, please enter the
following remarks.

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REMARKS

In the Office Action mailed on 25 February 2002, the Examiner stated that the
Amendment filed on 11 December 2001 was non-responsive due to an oversight by the
Applicants. The Examiner did not state whether the Amendment was entered by the
Examiner, but since the Examiner stated that the response appeared to be *bona fide*,
Applicants understand that the Amendment has been entered by the Examiner and therefore it
is not necessary to resubmit the Amendment herewith. Otherwise, the entirety of that
Amendment is incorporated herein by reference and together with this "Supplemental
Amendment" forms the entirety of Applicants' response.